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K430WQC-V3-F

Product

Standard LCD Module 480 x RGB x 272 Dots 4.3" 16.7M colors TFT display Wide temperature With white LED backlight With touch panel

Kitronix (Dong Guan) Ltd.



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	nt revision n	istory:		
DOCUMENT	DATE	DESCRIPTION	PREPARED	APPROVED
REVISION			BY	BY
01	2010.07.22	First Release.	MF Zou	



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2. General Description

- 4.3"(diagonal), 480 x RGB x 272 dots, 16.7M colors, Normal white TN, TFT LCD module.
- Viewing Direction: 6 o'clock.
- Controller: SSD1963 graphic controller/driver.
- 8080 system 16-bits
- With internal voltage booster.
- Logic voltage: 3.3V (typ.).

3. Mechanical Specifications

The mechanical detail is shown in Fig. 1 and summarized in Table 1 below.

Table 1

Par	rameter	Specifications	Unit
Outline	dimensions	105.5(W) x 67.2(H) x 9.4(D) (Exclude FPC, cables of backlight)	mm
	TP active area	96.70(W) x 55.50(H)	mm
	TP view area	98.70(W)x57.50(H)	mm
Color TFT	LCD active area	95.04(W) x 53.856(H)	mm
480xRGBx272	Display format	480 x RGB x 272	dots
	Color configuration	RGB Side-stripes	_
	Dot size	0. 198 (W) x 0.198(RGB)	mm
Weight		TBD	grams



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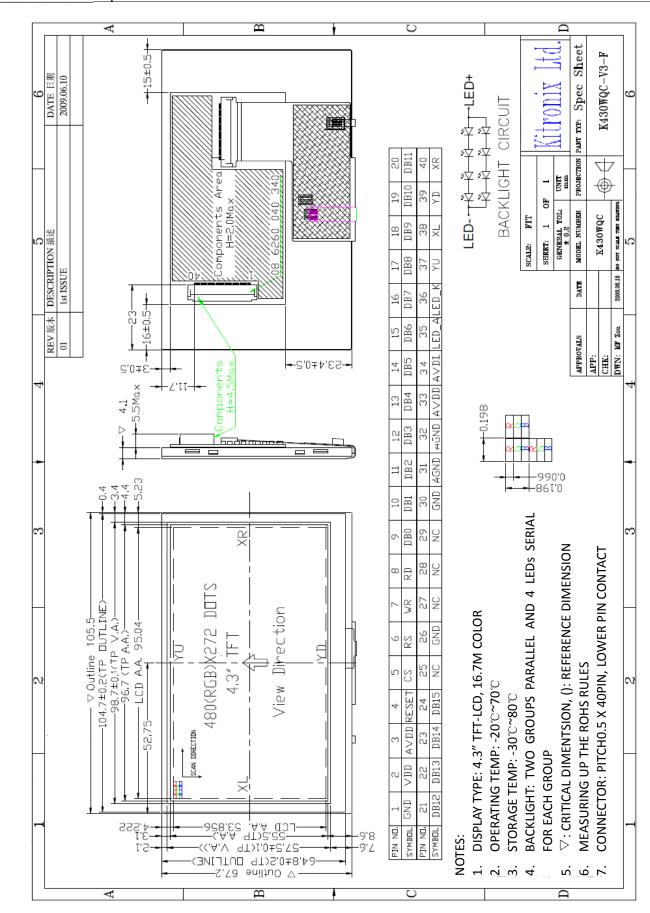


Figure 1: Outline Drawing



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4. Interface signals

Table 2: Pin assignment

Pin No.	Symbol	Description
1	GND	Ground for digital circuit
2	VDD	Power supply for digital circuit ($VDD = 3.3V$).
3	AVDD	Leave it OPEN.
4	RESET	External reset, active low.
5	CS	Chip select, active low.
6	RS	Command/data select.
7	WR	Write control.
8	RD	Read control.
9-24	[DB0-DB15]	16bit data bus
25	NC	NO CONNECT
26	GND	Ground for digital circuit
27-29	NC	NO CONNECT
30	GND	Ground for digital circuit
31-32	AGND	Connect to GND.
33-34	AVDD	Leave it OPEN.
35	LED-A	Anode of LED backlight (13.2V @ 40mA).
36	LED-K	Cathode of LED backlight.
37	YU	
38	XL	Terminal for touch panel
39	YD	
40	XR	



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5. Absolute Maximum Ratings

5.1 Electrical Maximum Ratings – for IC Only

Table 3: Electrical Maximum Ratings – for IC

Parameter	Symbol	Min.	Max.	Unit	Note
Supply voltage	VCC	-0.3	5.0	V	1
LED forward current	If		30	mA	
LED reverse	Vr		5.0	V	

Note:

- 1.VCC, GND must be maintained.
- 2. The modules may be destroyed if they are used beyond the absolute maximum ratings.

5.2 Envir onmental Condition

Table 4

Item	Operating temperature (Topr)		Stor temper (Ts (Not	Remark	
	Min.	Max.	Min.	Max.	
Ambient temperature	-20°C	+70°C	-30°C	+80°C	Dry
Humidity (Note 1)	80 < 50% RH for 40°	No condensation			

Note 1: Product cannot sustain at extreme storage conditions for long time.

6. Electrical Specifications

Typical Electrical Characteristics

At Ta = 25 °C, VCC=IOVCC= 3.3V, GND=0V.

Table 5

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply voltage (logic)	VCC-GND		3	3.3	3.6	V
Input signal voltage	VIH		0.8VCC	ı	VCC	V
input signal voltage	VIL		0	ı	0.2VCC	V
Supply current (Logic & LCD)	ICC	VDD=3.3V	-	15	19	mA
Supply voltage of white LED backlight	VLED	Forward current =20 mA Number of LED dies = 8	-	13.2	14	V



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7. Optical Characteristics

Table 7: Optical specifications

Items		Symbol	Condition	Specifications			Unit	
		Symbol	Condition	Min.	Тур.	Max.	Omi	
Contrast Ratio		CR		400	500	-	-	
Response Time		T_R+T_F		-	35	-	ms	
	Red	X_R		(0.598)	(0.618)	(0.638)	-	
	Red	Y_R		(0.298)	(0.318)	(0.338)	-	NT 4
	Green	X_{G}		(0.277)	(0.297)	(0.317)	-	Note
Chromaticity		Y_{G}		(0.525)	(0.545)	(0.565)	-	
	Blue	Хв		(0.114)	(0.134)	(0.154)	-	
		Y_{B}		(0.120)	(0.140)	(0.160)	-	
	White	Xw		(0.283)	(0.303)	(0.323)	-	
	vv III tC	Yw		(0.320)	(0.340)	(0.360)	-	
Viewing angle	Hor.	Φ 1 + Φ 2	Center	100	110	-	deg.	
viewing angle	Ver.	Φ 1 + Φ 2	CR=10	120	130	-	ucg.	
NTSC ratio					51.7		%	

Note 1: Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63

L0: Luminance of gray level 0

CR = CR (10)

CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note 5.

Note 2: Definition of Response Time (TR, TF):

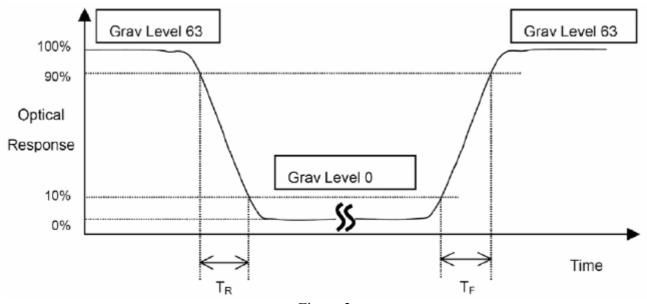
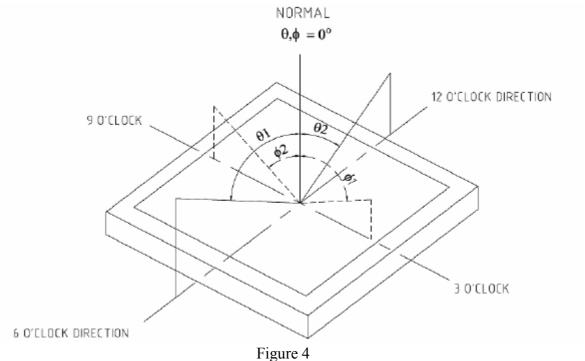


Figure 3



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Note 3: Viewing Angle



The above "Viewing Angle" is the measuring position with Largest Contrast Ratio; not for good image quality. View Direction for good image quality is 6 O'clock. Module maker can increase the "Viewing Angle" by applying Wide View Film.

Note 4: Measurement Set-Up:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.

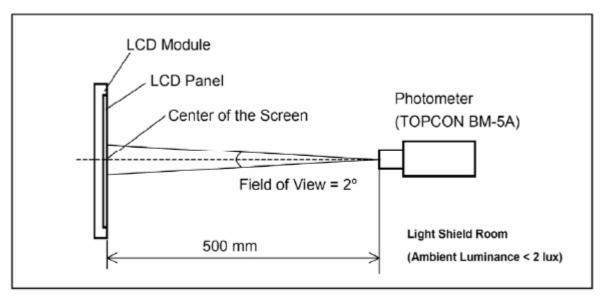


Figure 5



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8. Reliability Test Item

Test Item	Sample Type	Test Condi tion	Test result determinant gist
High temperature	Normal temperature	70±3℃;96H	the inspection of
storage	Wide temperature	80±3℃;96H	appearance and function
Low temperature	Normal temperature	-20±3℃;120H	character.
storage	Wide temperature	-30±3℃;120H	
High temperature	Normal temperature	50°C±3°C,90%±3%RH;96H	
/humidity storage	Wide temperature	60°C±3°C,90%±3%RH;96H	
High temperature	Normal temperature	60±3℃;96H	no objection of the function
operation	Wide temperature	70±3℃;96H	character; no fatal objection of
Low temperature	Normal temperature	0±3°C;96H	the appearance.
operation	Wide temperature	-20±3°C;96H	
High temperature		40°C±3°C,90%±3%RH;96H	
/humidity operation	Wide temperature	50°C±3°C,90%±3%RH;96H	
Temperature Sh ock	Normal temperature	-20±3 °C,30min? 70±3 °C,30 min;10cycle	inspect the objections appearance, function & the whole structure
	Wide temperature	-30±3 °C,30min 80±3,30min;10cycle	The inspection of appearance function & the whole structure



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9. Suggestions for using LCD modules

9.1 Handling of LCM

- 9.1.1. The LCD screen is made of glass. Don't give excessive external shock, or drop from a high place.
- 9.1.2. If the LCD screen is damaged and the liquid crystal leaks out, do not lick and swallow. When the liquid is attach to your hand, skin, cloth etc, wash it off by using soap and water thoroughly and immediately.
- 9.1.3. Don't apply excessive force on the surface of the LCM.
- 9.1.4. If the surface is contaminated ,clean it with soft cloth. If the LCM is severely contaminated , use Isopropyl alcohol/Ethyl alcohol to clean. Other solvents may damage the polarizer . The following solvents is especially prohibited: water , ketone Aromatic solvents etc.
- 9.1.5. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 9.1.6. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 9.1.7. Don't disassemble the LCM.
- 9.1.8. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment
 - Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded.
 - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.
 - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- 9.1.9. Do not alter, modify or change the the shape of the tab on the metal frame.
- 9.1.10. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

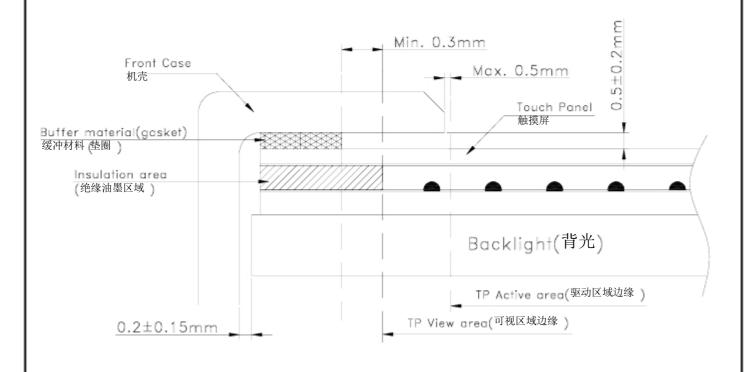


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- 9.1.11. Do not damage or modify the pattern writing on the printed circuit board.
- 9.1.12. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector
- 9.1.13. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- 9.1.14. Do not drop, bend or twist LCM.

9.2 Cautions for installing and assemably if the module with Touch Panel

- 9.2.1. Use a buffer material (Gasket) between the touch panel and Front-case to protect damage and wrong operating. The dimension of the buffer material's edge between the TP V.A. edge is Min. 0.3mm.
- 9.2.2. We recommend to design a case that it can't over the boundary of the active area Max. 0.5mm in order to prevent an operation at outside of the active area which can't guarantee the specified durability, because operation at the outside of the active area cause serious damage of a transparent.
- 9.2.3. When design case for installing Module, you would consider give a distance about 0.2±0.15mm between the module edge to case inside.
- 9.2.4. The corners of the product are not chamfered. When positioning and fixing the product on the case, we sugguest that you would provide a R part on the conner of the case so as not to apply load on the corner of the transparent module.





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9.3 Storage

- 9.3.1. Store in an ambient temperature of 5 to 45 °C, and in a relative humidity of 40% to 60%. Don't expose to sunlight or fluorescent light.
- 9.3.2. Storage in a clean environment, free from dust, active gas, and solvent.
- 9.3.3. Store in antistatic container.



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10. Inspection Standard

This specification is made to be used as the standard acceptance/rejection criteria for Color mobile phone LCM with touch pannel.

10.1 Sample plan and Inspection condition

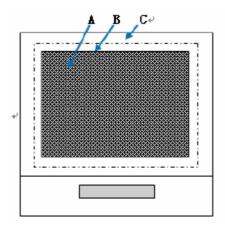
10.1.1 Sample plan

Sampling plan according to MIL-STD-105E, normal level 2 and based on:

Major defect: AQL 0.65; Minor defect: AQL 1.5. 10.1.2 Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45 against perpendicular line.

10.2 Definition of inspection zone in LCD



Inspection zones in an LCD

Zone A: character/Digit area;

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area);

Zone C: Outside viewing area (invisible area after assembly in customer's product);

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product. Defects are classified as major defects and minor defects according to the degree of defectiveness defined herein.

10.3 Major defects and Minor defects

10.3.1 Major defects

A major defect is a defect that is likely to result in failure, or to reduce the usability of the product for its intended purpose.

10.3.1.1 Abnormal operation: modules cannot display normally;

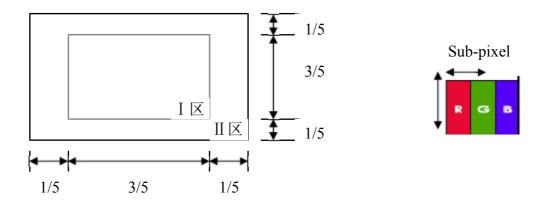


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- 10.3.1.2 Line defect;
- 10.3.1.3 There is serious distortion or sharp burr on mechanical housing;
- 10.3.1.4 Glass breakage.
- 10.3.2 Minor defects:

A minor defect is a defect that is not likely to reduce the usability of the product for its intended purpose.

- 10.3.2.1 Dot defect:
- 10.3.2.1.1 Inspection pattern: Full white, full black, red, green and blue screens;
- 10.3.2.1.2 Criteria:(acceptable);



Note: 1. Dot defect is defined as the defective area of the dot area is larger than 50% of the dot area. And the bright dot defect must be visible through 5% ND filter.

- 2. Except for the allowed numbers of adjacent dots, the distance between dot defects should be more than 3mm apart.
- 10.3.2.1.3 The definitions of the inner display area and outer display area.

10.4 Inspection standards table:

10.4.1 Major defect

Item No.	Items to be	Inspection Standard	Classification of defects
10.4.1.1	All functional defects	 No display Display abnormally Missing vertical/horizontal segment Short circuit Back-light no lighting, flickering and abnormal lighting. 	Major
10.4.1.2	Missing	Missing component	
10.4.1.3 Outline dimension		Overall outline dimension beyond the drawing is not allowed.	
10.4.1.4	linearity	No more than 1.5%	



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10.4.2 Cosmetic Defect (spot defect)

ear Spots ack and nite not defect nhole, reign rticle, larizer	For dark/white spo as F=(x +y)/2 Zone Size(mm) F=0.1 0.10 <f=0.15< th=""><th></th><th>Acceptabl</th><th>e Qty</th><th>Minor</th></f=0.15<>		Acceptabl	e Qty	Minor
nhole, reign rticle, larizer	Size(mm) F=0.1 0.10 <f=0.15< td=""><td>A</td><td></td><td></td><td></td></f=0.15<>	A			
reign rticle, larizer	F=0.1 0.10 <f=0.15< td=""><td></td><td>В</td><td>\mathcal{C}</td><td>1 1</td></f=0.15<>		В	\mathcal{C}	1 1
rticle, larizer	0.10 <f=0.15< td=""><td>Ign</td><td></td><td>C</td><td></td></f=0.15<>	Ign		C	
larizer			ore		Minor
		2		Ignore	
11	0.15 <f=0.20< td=""><td>1</td><td></td><td>C</td><td></td></f=0.20<>	1		C	
	F>0.20	0	0		
	Zone	Acceptable Qty			
Clear Spots TP Dirt	Size(mm)	A	В	С	
	F=0.1	Ignore			Minor
	0.10 <f=0.15< td=""><td colspan="2">2</td><td>Ignore</td><td></td></f=0.15<>	2		Ignore	
	0.15 <f=0.25< td=""><td colspan="2">1</td><td>C</td><td></td></f=0.25<>	1		C	
	F>0.25	0	0		
m Spots	Zone		Acceptable Q		
rcle	Size(mm)	A	В	С	T
aped and	F=0.2	Igno	ore		Minor
	0.20 <f=0.4< td=""><td>2</td><td></td><td>Ignore</td><td></td></f=0.4<>	2		Ignore	
iecis	0.4 < F=0.6	1		\mathcal{E}	
	F>0.6	0			
	dot =sub-pixel				
			Acceptabl	e Qty]
ot defect		I		II	Minor
	Bright dot	Bright dot 0		2	1
	Dark dot	point >5mm			-
f	n edged ects	t defect $0.20 < F=0.4$ $0.4 < F=0.6$ $F>0.6$ $dot = sub-pixel$ Bright dot			th edged ects

10.4.3 Cosmetic Defect (linear defect)

Item No	Items to be		Classification of defects				
	Line defect Black line, White line, Foreign material on polarizer	Size(mm)		Acceptable Qty			
		Black line, L(Length)	W(Width)		zone		
10.4.3.1				A	В	C	Minor
		Ignore	W=0.02	Ignore			
		L=3.0	0.02 < W = 0.03	2		Ignore	
		L=2.0	0.03 < W = 0.05			8	
			W>0.05	Define as sp	oot defect		



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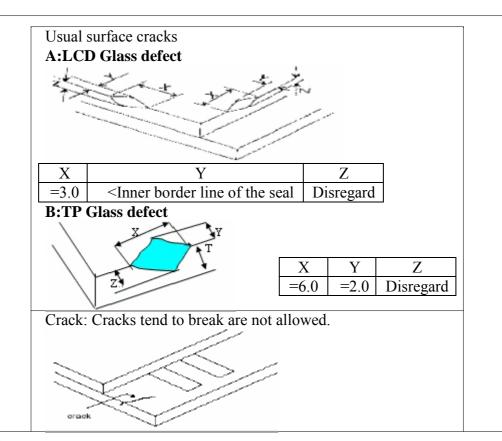
	Foreign Material on TP film	The line can be seen after mobile phone in the operating condition:							
10.4.3.2		Size(mm)			Acceptable Qty				
		L(Length)	W((Width)		zone			
		T	<u> </u>		A	B C			Minor
		Ignore	W=0.0			Ignore		1	
		L=3.0	0.03<	W=0.05		3		Ignore	
			W>0	0.05	Define	as spot defe	ect		
	Dim line defect Polarizer &BL scratch TP film scratch	If the scratch can be seen after mobile phone cover assembling or in the operating condition, judge by the line defect of 10.4.3.1. If the scratch can be seen only in non-operating condition or some special angle, judge by the following.							
		Size(mm)			Acceptable Qty				Minor
10.4.3.3		1.71 (1.)	W (Width)		zone				
10.4.3.3		L(Length)			A	В С			IVIIIOI
		Ignore W =0.02			Ignore				
		L≤3.0	0.02 <w=0.03 0.03<w=0.05< td=""><td></td><td>2</td><td></td><td>Ignore</td><td rowspan="3"></td></w=0.05<></w=0.03 			2		Ignore	
		L≤2.0				1		ignore	
			W>0	.05	Define	as spot def	s spot defect		
	Polarize Air bubble	Air bubbles between glass & polarizer							
10.4.3.4				Acceptable Qty					
				A		В		С	
		F=0.2		Ignore			Ignore	Minor	
		0.20 <f=0.3< td=""><td colspan="3">2</td><td>] ,</td></f=0.3<>		2] ,
		0.3 <f=0.5< td=""><td colspan="3">1</td><td>] 1</td></f=0.5<>		1] 1
		Φ>0.5			0				

10.4.4 Chipping Defect

Item No	Items to be	Inspection Standard		Classification of defects
10.4.4.1	Glass defect	Notes: S=contact pad length Chips on the corner of terminal shall not be allowed to ex ITO pad or expose perimeter seal. B:TP Glass defect X X X X X X X X X X X X X X X X X X	Y Z S Disregard tend into the Y Z S.0 Disregard	Minor



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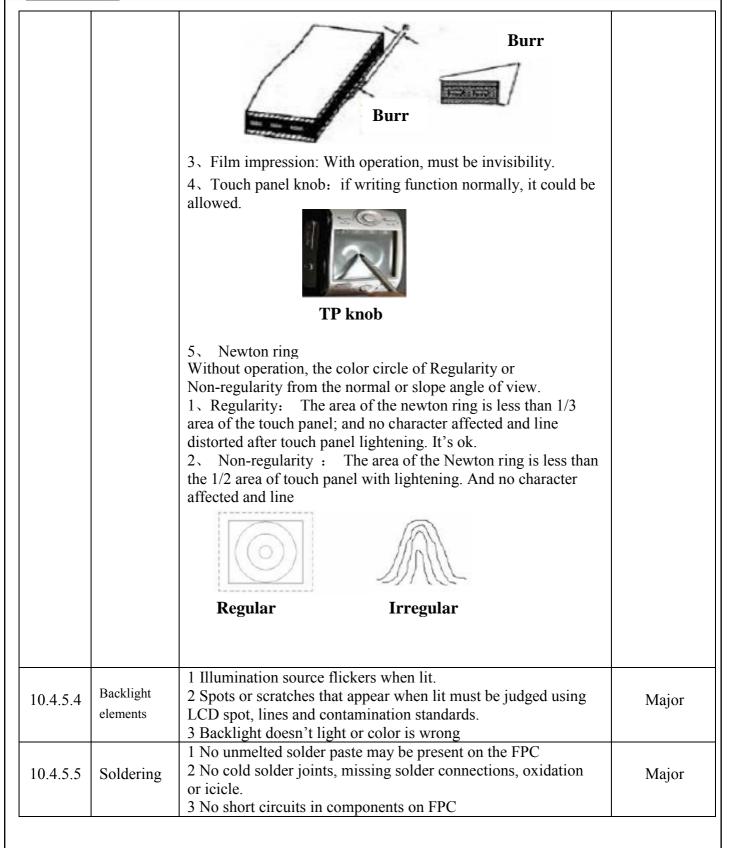


10.4.5 Parts Defect

10.1.51 at	10.4.3 Faits Defect						
Item No	Items to be	Inspection Standard	Classification of defects				
10.4.5.1	Parts contra position	 Not allow IC and FPC/heat-seal lead width is more than 50% beyond lead pattern. Not allow chip or solder component is off center more than 50% of the pad outline. 	Major				
10.4.5.2	SMT	According to the According to the Acceptability of electronic assemblies>IPC-A-610C class 2 standard. Component missing or function defect are Major defect, the others are Minor defect.	Major				
10.4.5.3	TP Defect	1. Pattern font: Pattern fonts are clear and symmetrical, pattern fonts filter lightly are allowed; The fort line is not allow to thinner or thicker than 1/3 of normal size, and swing is not more than 0.1mm. the line is smooth and not broken. Pattern font	Major				
		2. The wing forward in the side of Visual Area: The length of wing forward inside of the Visual Area: n=0.2mm; Not excess 3 point, and the distance D=20mm.					



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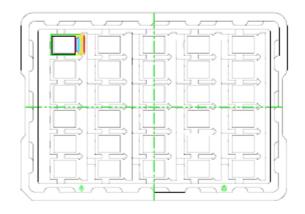


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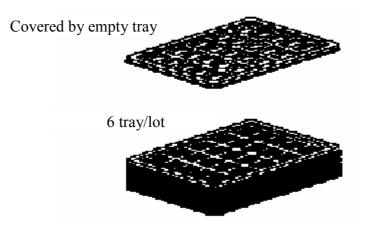
11. Packing (Reference only)

Packing Method

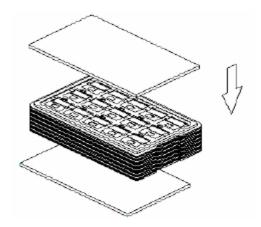
(1) 10pcs modules/tray



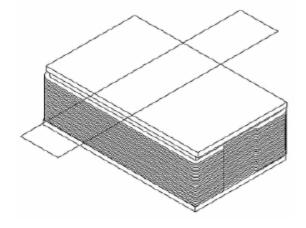
(2) 6 tray stacking/lot



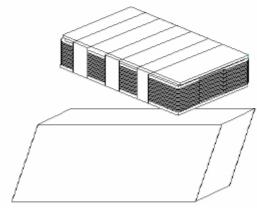
(3) 2 EPE cushion/lot



(4) Fixing by type

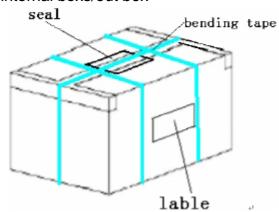


(5) 1 lot/internal box



Size:383.0x270.0x66.0mm

(6) 6 internal boxs/out box



Size:570.0x410.0x265.0mm Total: 360pcs module/out box